Tzong-Da HO Chien-Ping HUANG OG/25/01 Additional names(s) of conveying party(ies) Yes X No 3. Nature of conveyance: X Assignment	EET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
Tab settings Image: Setings Image: Settings Imag	ease record the attached original documents or copy thereof. 2. Name and address of receiving party(ies): Name: Siliconware Precision Industries Co., Ltd. Address: No. 123, Sec. 3, Da Fong Rd. Tantzu, Taichung, Taiwan, R.O.C.
1. Name of conveying party(ies): 2 Tzong-Da HO 0 Chien-Ping HUANG 0 Additional names(s) of conveying party(ies) □ Yes ⊠ No 3. Nature of conveyance: ⊠ ▲ Assignment □ Merger	2. Name and address of receiving party(ies): Name: Siliconware Precision Industries Co., Ltd. Address: No. 123, Sec. 3, Da Fong Rd. Tantzu, Taichung, Taiwan, R.O.C.
Tzong-Da HO Chien-Ping HUANG OG/25/01 Additional names(s) of conveying party(ies) Yes X No 3. Nature of conveyance: X Assignment	Name: Siliconware Precision Industries Co., Ltd. Address: No. 123, Sec. 3, Da Fong Rd. Tantzu, Taichung, Taiwan, R.O.C. Image: Color of the second secon
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Assignment Merger	
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If this document is being filed together with a new application, the Patent Application No. Filing date 05 26. 2001 AADJF0: 000(0041 09962596 06 F0.581 40. 10 JP	e execution date of the application is: <u>September 25, 2001</u> B. Patent No.(s)
Additional numbers	🗋 Yes 🛛 No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Peter F. Corless 7	7. Total fee (37 CFR 3.41):\$ 40.00
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	In consideration of the sum of One Dollar (\$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned
Inventor(s) Full Name(s)	1) TZONG-DA HO
	2) CHIEN-PING HUANG
	• • • • • • • • • • • • • • • • • • • •
	hereby sell, assign and transfer to
Assignee	SILICONWARE PRECISION INDUSTRIES CO., LTD.
Name and Address	No. 123, Sec. 3, Da Fong Rd., Tantzu, Taichung, Taiwan, R.O.C.
	······································
	(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled
Title of Invention	SEMICONDUCTOR PACKAGE
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	which application was
Complete	a) executed by the undersigned on the day of
either a) or b)	b) filed on the day of , 19
	Serial No
	It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said Assignee.
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Date	Signed at TAICHUNG
	this. 27th day of JULY
Inventor(s)	INVENTOR(S):
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Witnesses' Full	WITNESSES:
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ASSIGNMENT OF U.S. PATENT APPLICATION

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